

# IRF9530NS/L

HEXFET® Power MOSFET

- Advanced Process Technology
- Surface Mount (IRF9530NS)
- Low-profile through-hole (IRF9530NL)
- 175°C Operating Temperature
- Fast Switching
- P-Channel
- Fully Avalanche Rated

## Description

Fifth Generation HEXFETs from International Rectifier utilize advanced processing techniques to achieve extremely low on-resistance per silicon area. This benefit, combined with the fast switching speed and ruggedized device design that HEXFET Power MOSFETs are well known for, provides the designer with an extremely efficient and reliable device for use in a wide variety of applications.

The D<sup>2</sup>Pak is a surface mount power package capable of accommodating die sizes up to HEX-4. It provides the highest power capability and the lowest possible on-resistance in any existing surface mount package. The D<sup>2</sup>Pak is suitable for high current applications because of its low internal connection resistance and can dissipate up to 2.0W in a typical surface mount application.

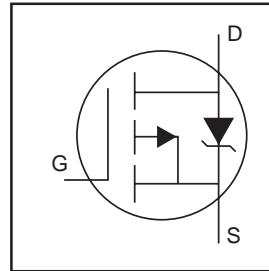
The through-hole version (IRF9530NL) is available for low-profile applications.

## Absolute Maximum Ratings

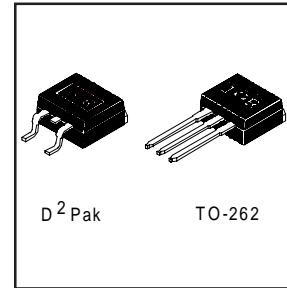
	Parameter	Max.	Units
I <sub>D</sub> @ T <sub>C</sub> = 25°C	Continuous Drain Current, V <sub>GS</sub> @ -10V <sup>⑤</sup>	-14	A
I <sub>D</sub> @ T <sub>C</sub> = 100°C	Continuous Drain Current, V <sub>GS</sub> @ -10V <sup>⑤</sup>	-10	
I <sub>DM</sub>	Pulsed Drain Current ①⑤	-56	
P <sub>D</sub> @ T <sub>A</sub> = 25°C	Power Dissipation	3.8	W
P <sub>D</sub> @ T <sub>C</sub> = 25°C	Power Dissipation	79	W
	Linear Derating Factor	0.53	W/°C
V <sub>GS</sub>	Gate-to-Source Voltage	± 20	V
E <sub>AS</sub>	Single Pulse Avalanche Energy <sup>②⑤</sup>	250	mJ
I <sub>AR</sub>	Avalanche Current <sup>①</sup>	-8.4	A
E <sub>AR</sub>	Repetitive Avalanche Energy <sup>①</sup>	7.9	mJ
dv/dt	Peak Diode Recovery dv/dt <sup>③⑤</sup>	-5.0	V/ns
T <sub>J</sub>	Operating Junction and	-55 to + 175	°C
T <sub>STG</sub>	Storage Temperature Range		
	Soldering Temperature, for 10 seconds	300 (1.6mm from case )	

## Thermal Resistance

	Parameter	Typ.	Max.	Units
R <sub>θJC</sub>	Junction-to-Case	—	1.9	°C/W
R <sub>θJA</sub>	Junction-to-Ambient ( PCB Mounted,steady-state)**	—	40	



$V_{DSS} = -100V$   
 $R_{DS(on)} = 0.20\Omega$   
 $I_D = -14A$



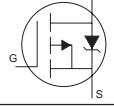
# IRF9530NS/L

International  
Rectifier

## Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(\text{BR})\text{DSS}}$	Drain-to-Source Breakdown Voltage	-100	—	—	V	$V_{GS} = 0V, I_D = -250\mu\text{A}$
$\Delta V_{(\text{BR})\text{DSS}/\Delta T_J}$	Breakdown Voltage Temp. Coefficient	—	-0.11	—	$\text{V}/^\circ\text{C}$	Reference to $25^\circ\text{C}, I_D = -1\text{mA}$ ⑤
$R_{DS(\text{on})}$	Static Drain-to-Source On-Resistance	—	—	0.20	$\Omega$	$V_{GS} = -10V, I_D = -8.4\text{A}$ ④
$V_{GS(\text{th})}$	Gate Threshold Voltage	-2.0	—	-4.0	V	$V_{DS} = V_{GS}, I_D = -250\mu\text{A}$
$g_{fs}$	Forward Transconductance	3.2	—	—	S	$V_{DS} = -50V, I_D = -8.4\text{A}$ ⑤
$I_{DSS}$	Drain-to-Source Leakage Current	—	—	-25	$\mu\text{A}$	$V_{DS} = -100V, V_{GS} = 0V$
		—	—	-250		$V_{DS} = -80V, V_{GS} = 0V, T_J = 150^\circ\text{C}$
$I_{GSS}$	Gate-to-Source Forward Leakage	—	—	100	$\text{nA}$	$V_{GS} = 20V$
	Gate-to-Source Reverse Leakage	—	—	-100		$V_{GS} = -20V$
$Q_g$	Total Gate Charge	—	—	58	$\text{nC}$	$I_D = -8.4\text{A}$
$Q_{gs}$	Gate-to-Source Charge	—	—	8.3		$V_{DS} = -80V$
$Q_{gd}$	Gate-to-Drain ("Miller") Charge	—	—	32		$V_{GS} = -10V$ , See Fig. 6 and 13 ④⑤
$t_{d(on)}$	Turn-On Delay Time	—	15	—	$\text{ns}$	$V_{DD} = -50V$
$t_r$	Rise Time	—	58	—		$I_D = -8.4\text{A}$
$t_{d(off)}$	Turn-Off Delay Time	—	45	—		$R_G = 9.1\Omega$
$t_f$	Fall Time	—	46	—		$R_D = 6.2\Omega$ , See Fig. 10 ④
$L_s$	Internal Source Inductance	—	7.5	—	$\text{nH}$	Between lead, and center of die contact
$C_{iss}$	Input Capacitance	—	760	—	$\text{pF}$	$V_{GS} = 0V$
$C_{oss}$	Output Capacitance	—	260	—		$V_{DS} = -25V$
$C_{rss}$	Reverse Transfer Capacitance	—	170	—		$f = 1.0\text{MHz}$ , See Fig. 5 ⑤

## Source-Drain Ratings and Characteristics

	Parameter	Min.	Typ.	Max.	Units	Conditions
$I_S$	Continuous Source Current (Body Diode)	—	—	-14	$A$	MOSFET symbol showing the integral reverse p-n junction diode. 
$I_{SM}$	Pulsed Source Current (Body Diode) ①⑤	—	—	-56		
$V_{SD}$	Diode Forward Voltage	—	—	-1.6	V	$T_J = 25^\circ\text{C}, I_S = -8.4\text{A}, V_{GS} = 0V$ ④
$t_{rr}$	Reverse Recovery Time	—	130	190	ns	$T_J = 25^\circ\text{C}, I_F = -8.4\text{A}$
$Q_{rr}$	Reverse Recovery Charge	—	650	970	nC	$di/dt = -100\text{A}/\mu\text{s}$ ④⑤
$t_{on}$	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by $L_s+L_D$ )				

### Notes:

① Repetitive rating; pulse width limited by max. junction temperature. ( See fig. 11 )

④ Pulse width  $\leq 300\mu\text{s}$ ; duty cycle  $\leq 2\%$ .

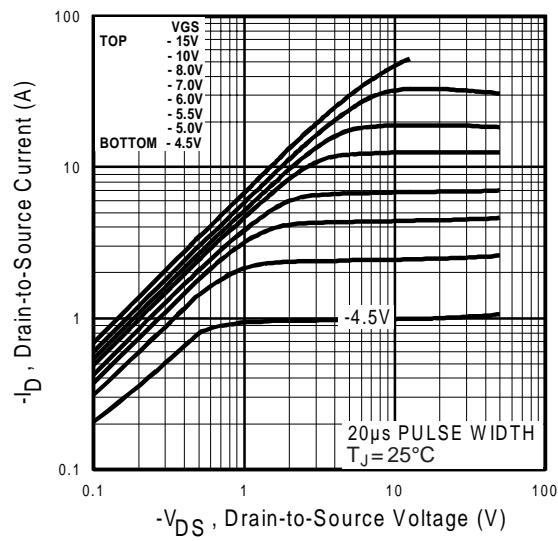
② Starting  $T_J = 25^\circ\text{C}, L = 7.0\text{mH}$   
 $R_G = 25\Omega, I_{AS} = -8.4\text{A}$ . (See Figure 12)

⑤ Uses IRF9530N data and test conditions

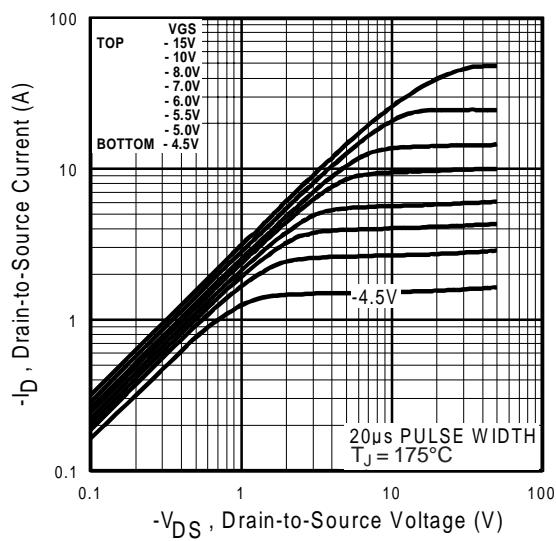
③  $I_{SD} \leq -8.4\text{A}, di/dt \leq -490\text{A}/\mu\text{s}, V_{DD} \leq V_{(\text{BR})\text{DSS}}, T_J \leq 175^\circ\text{C}$

\*\* When mounted on 1" square PCB (FR-4 or G-10 Material).

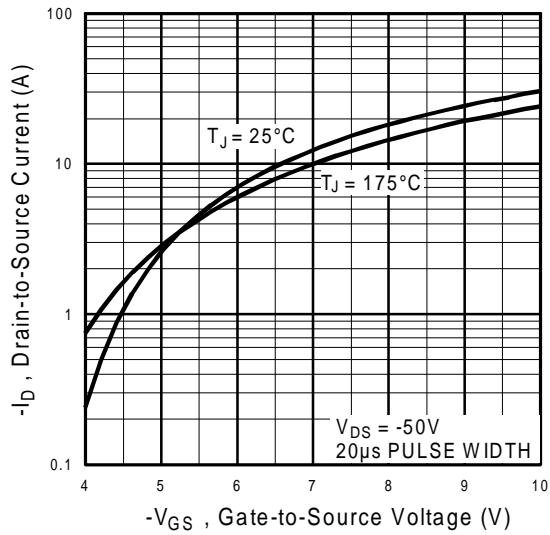
For recommended footprint and soldering techniques refer to application note #AN-994.



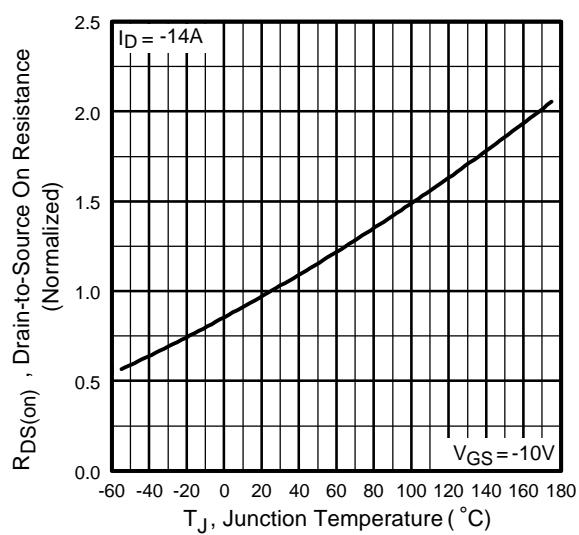
**Fig 1.** Typical Output Characteristics



**Fig 2.** Typical Output Characteristics



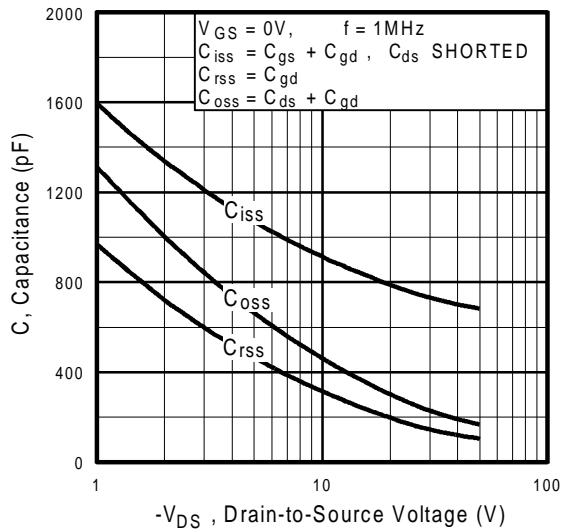
**Fig 3.** Typical Transfer Characteristics



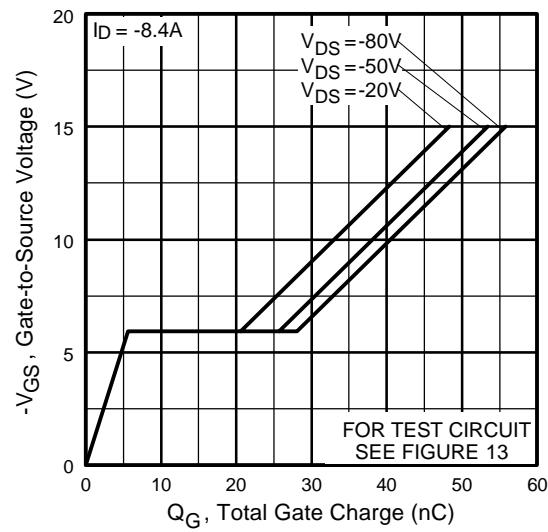
**Fig 4.** Normalized On-Resistance  
Vs. Temperature

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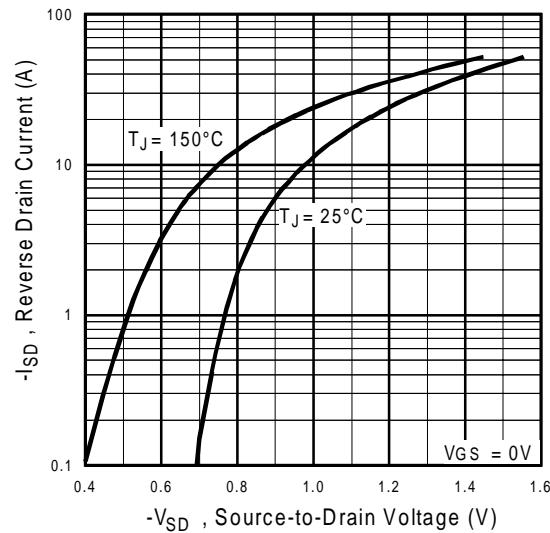
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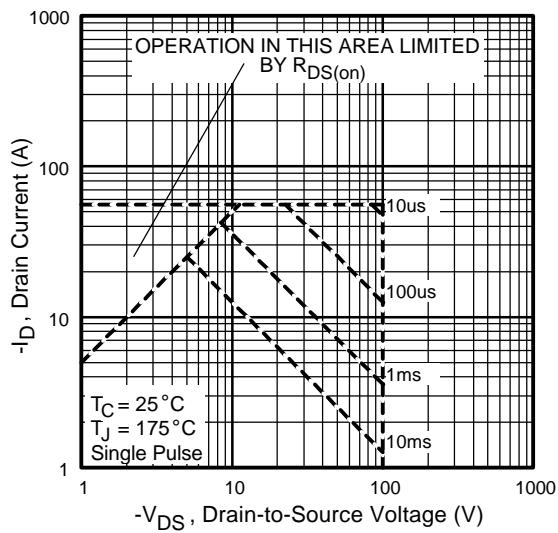
**Fig 5.** Typical Capacitance Vs.  
Drain-to-Source Voltage



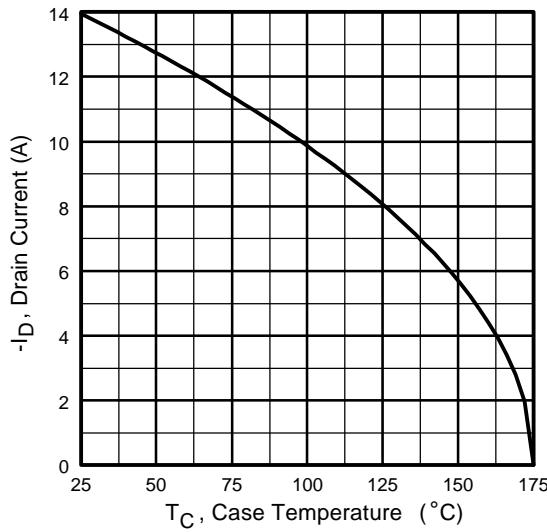
**Fig 6.** Typical Gate Charge Vs.  
Gate-to-Source Voltage



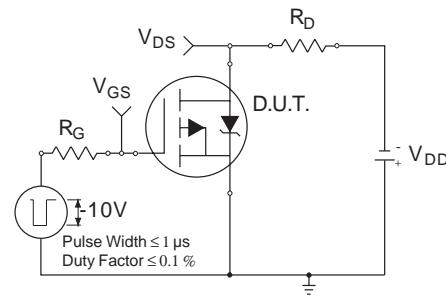
**Fig 7.** Typical Source-Drain Diode  
Forward Voltage



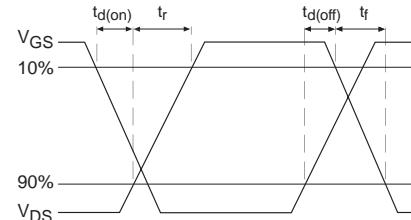
**Fig 8.** Maximum Safe Operating Area



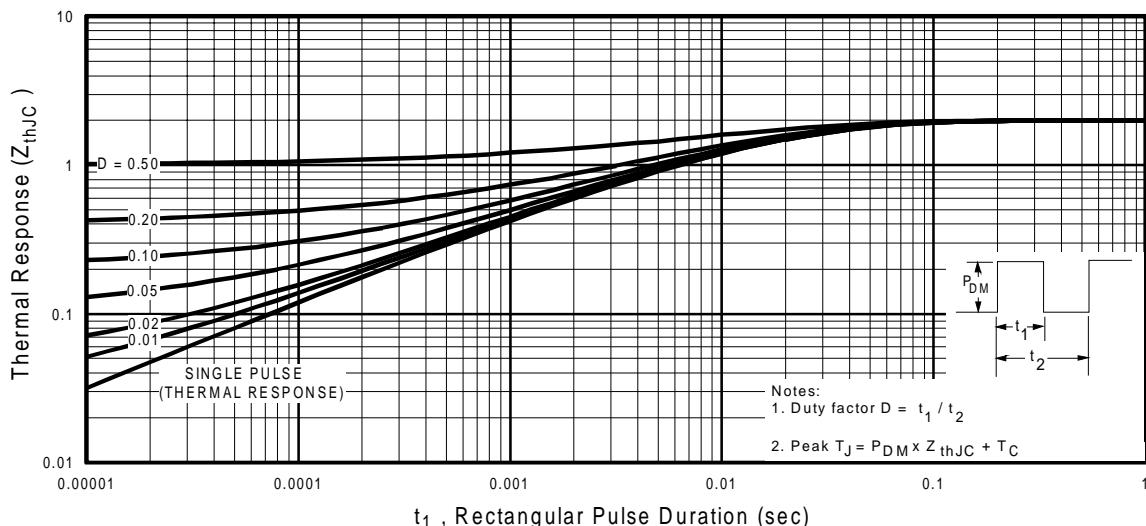
**Fig 9.** Maximum Drain Current Vs.  
Case Temperature



**Fig 10a.** Switching Time Test Circuit



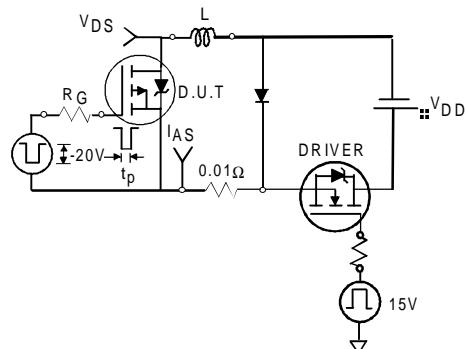
**Fig 10b.** Switching Time Waveforms



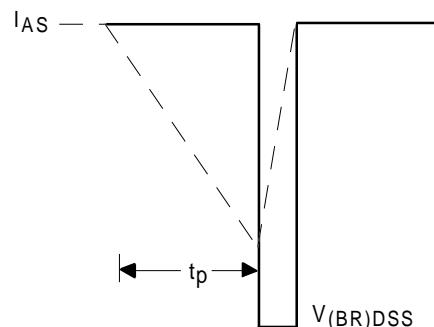
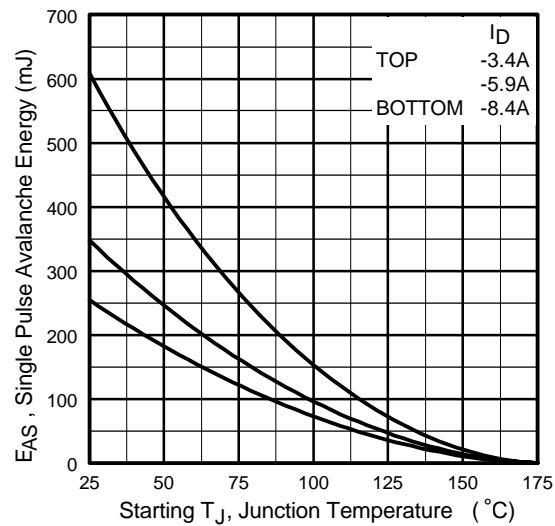
**Fig 11.** Maximum Effective Transient Thermal Impedance, Junction-to-Case

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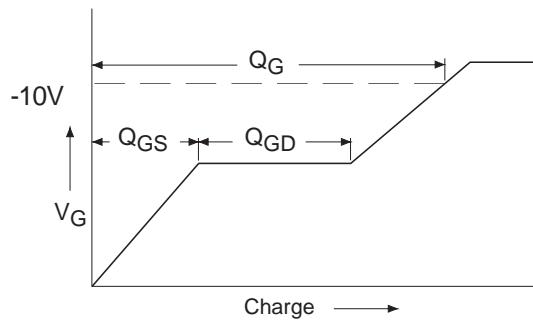
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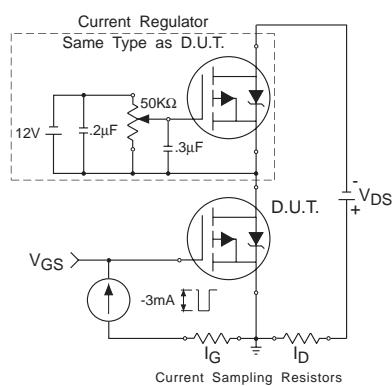
**Fig 12a.** Unclamped Inductive Test Circuit



**Fig 12b.** Unclamped Inductive Waveforms

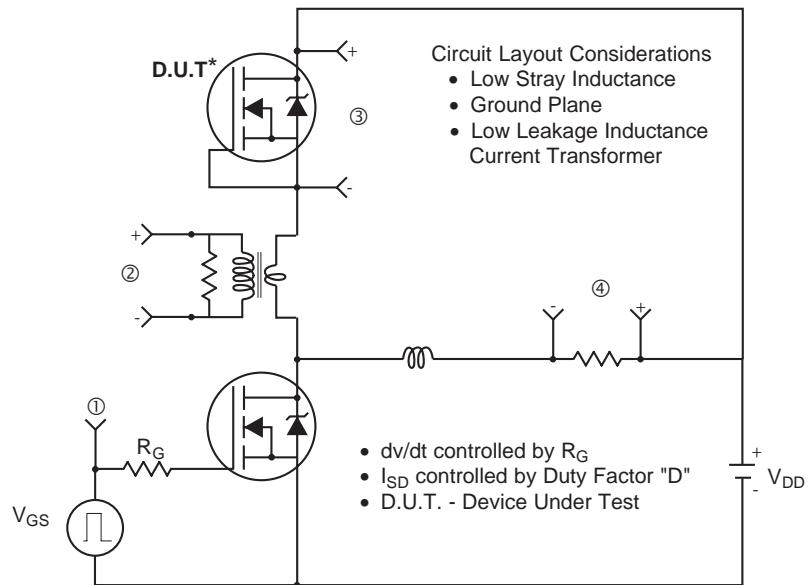


**Fig 13a.** Basic Gate Charge Waveform

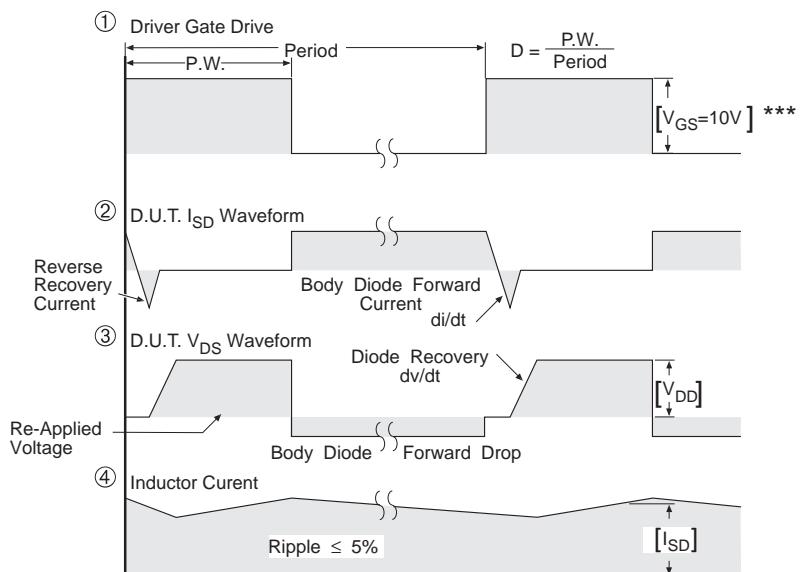


**Fig 13b.** Gate Charge Test Circuit

## Peak Diode Recovery dv/dt Test Circuit



\* Reverse Polarity of D.U.T. for P-Channel



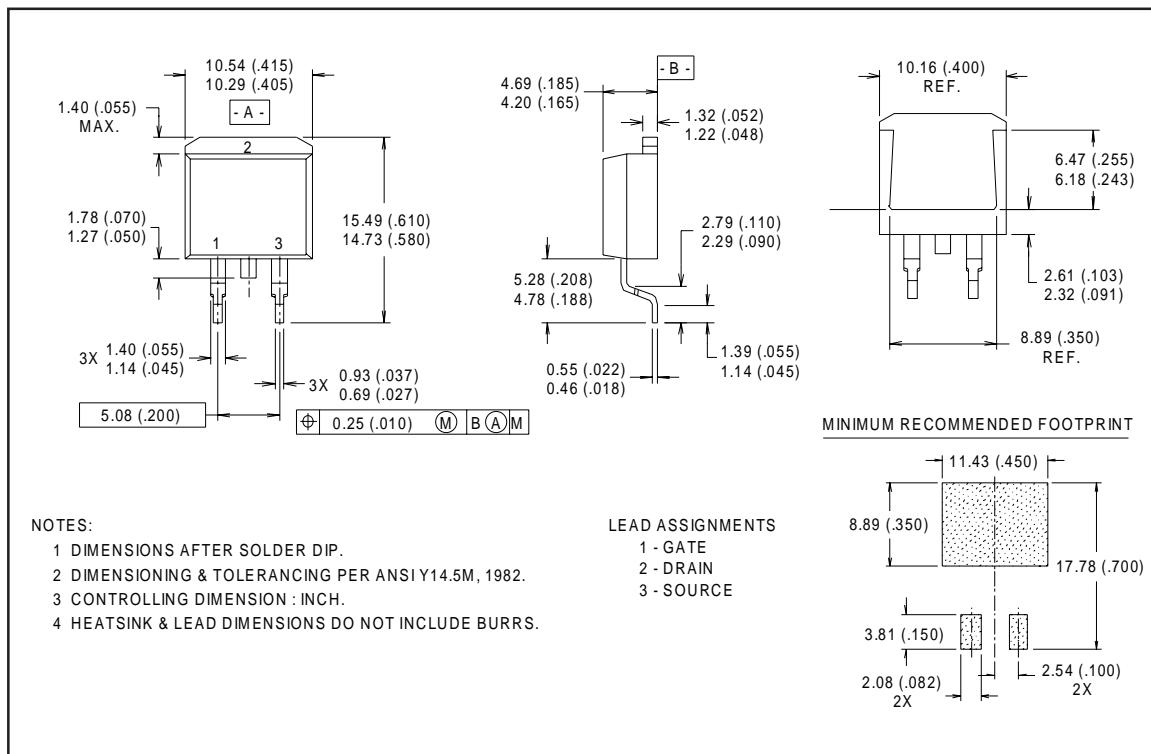
\*\*\*  $V_{GS} = 5.0\text{V}$  for Logic Level and 3V Drive Devices

**Fig 14.** For P-Channel HEXFETS

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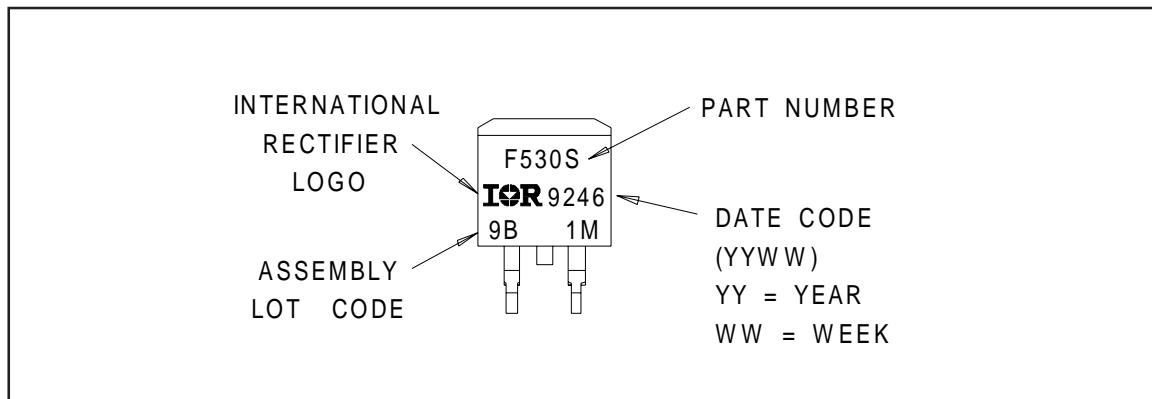
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## D<sup>2</sup>Pak Package Outline



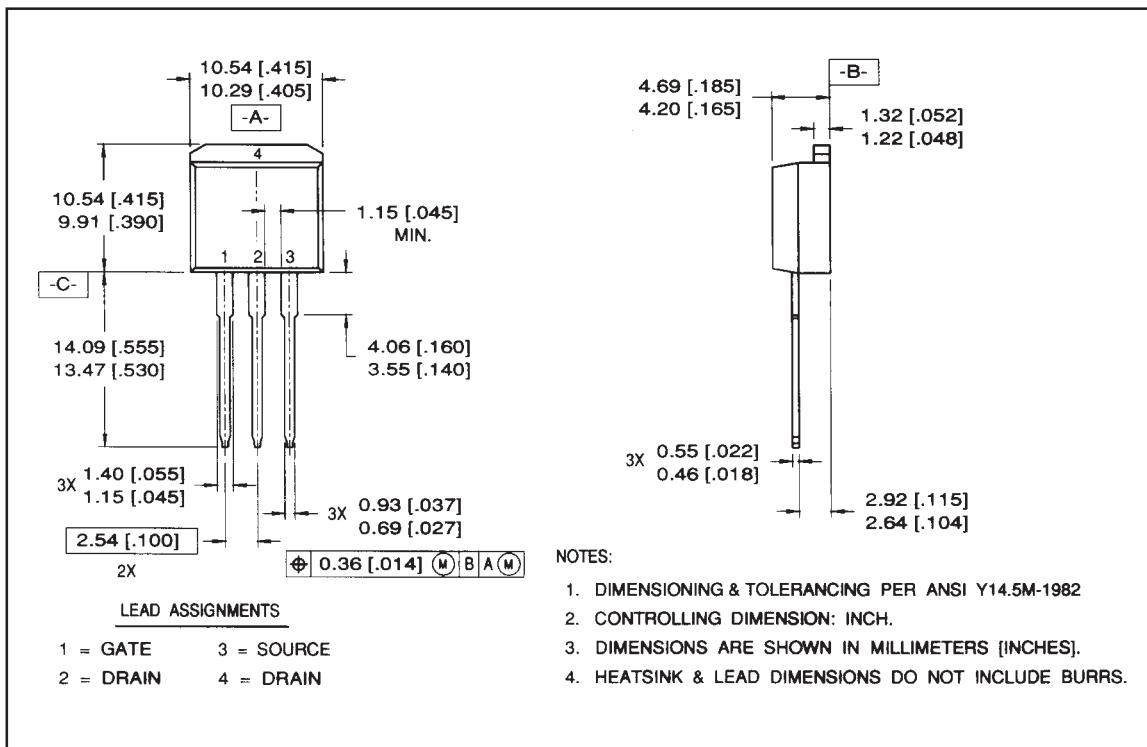
## Part Marking Information

D<sup>2</sup>Pak



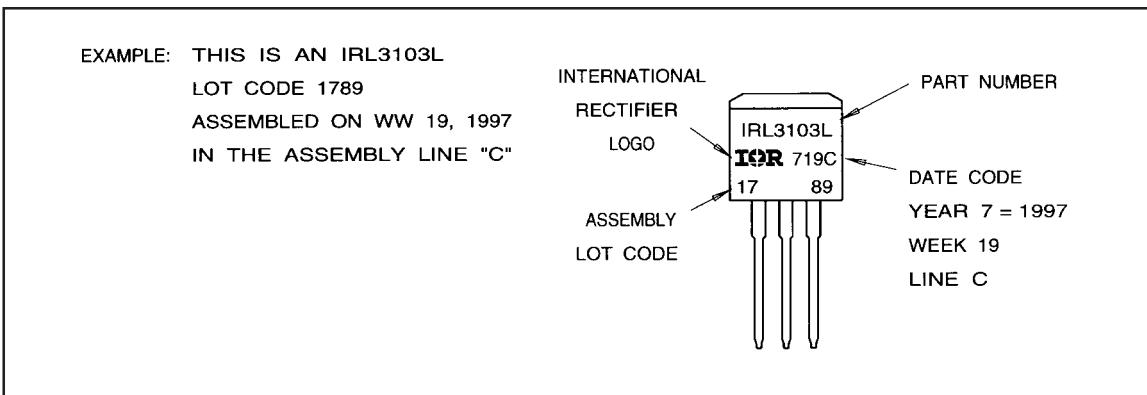
## Package Outline

### TO-262 Outline



## Part Marking Information

### TO-262

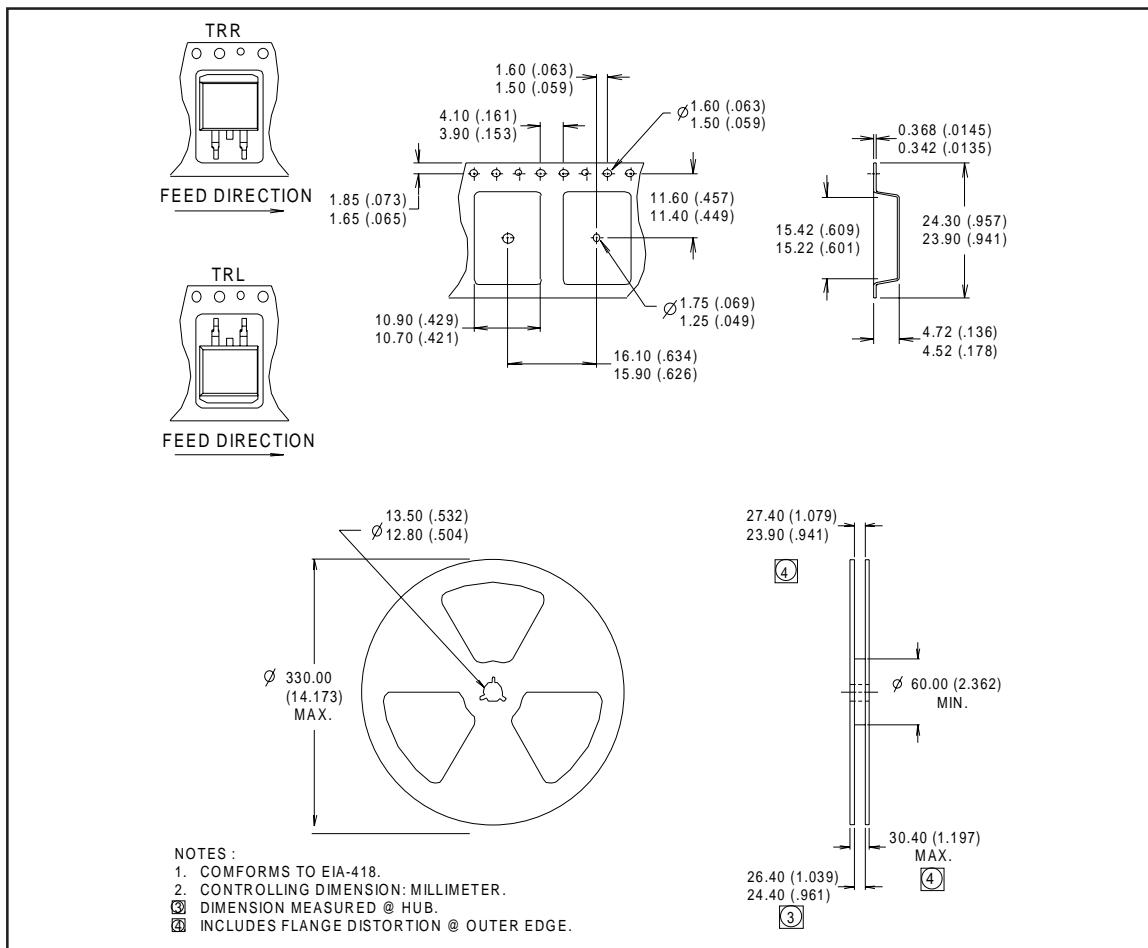


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## Tape & Reel Information

D<sup>2</sup>Pak



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**IR CANADA:** 7321 Victoria Park Ave., Suite 201, Markham, Ontario L3R 2Z8, Tel: (905) 475 1897

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Note: For the most current drawings please refer to the IR website at:  
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